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1. Applicant's Amendment filed 01/03/2006 has been reviewed and placed of record in the file.

## Allowable Subject Matter

2. Claims 10-14 and 27-32 (to be renumbered 1-11) are allowable over the prior art of record.

The following is an examiner's statement of reasons for allowance: The prior art of record fails to teach or render obvious a semiconductor device formed by flip-chip bonding a semiconductor chip to a carrier used for external connection with the semiconductor chip having all exclusive limitations as recited in claims 10, 27, and 30, characterized in that in the paddisposition restriction area of claim 10, or in the second I/O group of claim 27, or in the second and fourth I/O groups of claim 30, the inner pad array of the pad-disposition restriction area is individually bump-bonded to the interconnect pattern on the carrier surface and at least two of the electrode pads are short-circuited to each other inside the carrier, at least two of the at least two inner electrode pads in the second I/O group of claim 27 are electrically connected to an interconnect pattern of the carrier, or both an inner electrode pad of the at least two inner electrode pads of the at least two fourth I/O cells in the second I/O group and an inner electrode pad of the at least two inner electrode pads of the a

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Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

## Conclusion

3. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tu-Tu Ho whose telephone number is (571) 272-1778. The examiner can normally be reached on 6:30 am - 5:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, DAVID NELMS can be reached on (571) 272-1787. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Tu-Tu Ho

January 12, 2006